MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0500L1T-1

For Customer's Acceptance:

Customer		
Approved		
Comment		

Revision	1.1
Engineering	
Date	2013-01-07
Our Reference	





REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2012-12-25	First issue	
1.1	2013-01-07	Full spec	



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MODULE NO.: MI0500L1T-1

■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	5.0	Inch
Viewingdirection	12:00	O'Clock
Gray scale inversion direction	6:00	O'Clock
$LCM(W \times H \times D)$	120.70×75.80×3.10	mm ³
Active area (W×H)	110.88×62.83	mm^2
Number of dots	480 (RGB) × 272	/
Driver IC	ILI6482C	/
Backlight type	10 LEDs	/
Interface type	24 bits RGB	/
Color depth	16.7M	/
Color Pixel arrangement	Island RGB type	/
Input voltage	3.3	V
With/Without TSP	Without TSP	/
Weight	TBD	g

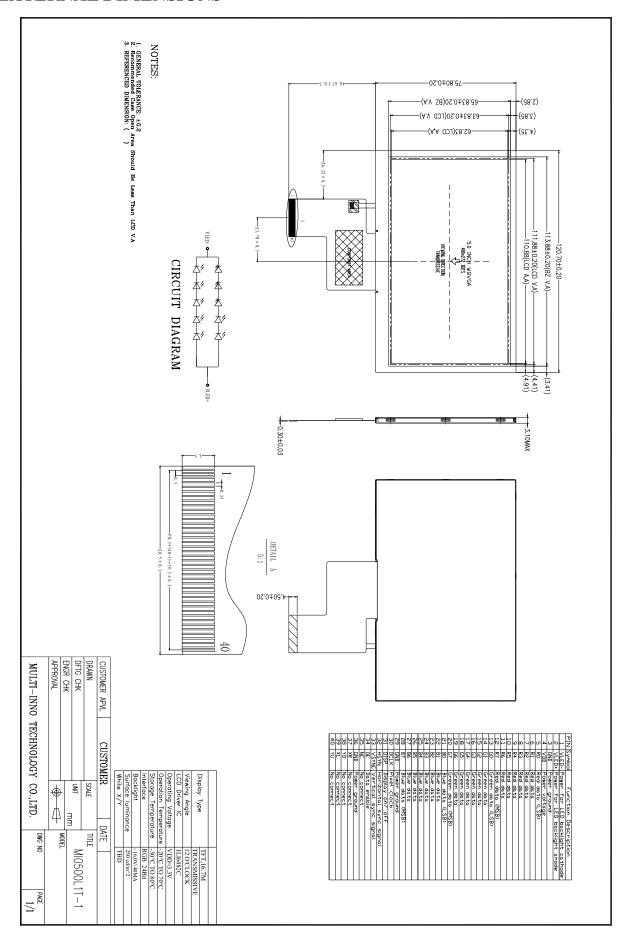
Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : RoHS compliant;

Note 3: LCM weight tolerance: ± 5%.



■ EXTERNAL DIMENSIONS





MODULE NO.: MI0500L1T-1 Ver 1.1

■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	VCC	-0.3	3.6	V
Input voltage for logic	VIN	-0.5	VCC+0.3	V
Supply current(One LED)	I LED	-	30	mA
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

■ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Supply voltage for logic	VCC	3.0	3.3	3.6	V
Current for driver	Ivcc	-	18	26	mA
Input voltage 'H'level	V _{IH}	0.8VCC	-	VCC	V
Input voltage 'L' level	VIL	-0.3	-	0.2VDD	V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	Vf	15.5	16.0	16.5	V	Note 1
Input backlight current	If	36	40	44	mA	
LED life time	-	20,000	-	-	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and $I_F = 40 \text{mA}$.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I_F =40mA. The LED lifetime could be decreased if operating I_F is lager than 40 mA.



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■ELECTRO-OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response	time	Tr+Tf			30		ms	FIG 1.	4
Contrast r	atio	Cr	θ=0°	350	500			FIG 2.	1
Luminar uniform		δ WHITE	Ø=0° Ta=25℃	80	85		%	FIG 2.	3
Surface Lum	inance	Lv		250	300	350	cd/m ²	FIG 2.	2
			Ø = 90°		55		deg	FIG 3.	
Viovving angl	Viewing angle range		Ø = 270°		65		deg	FIG 3.	$\begin{vmatrix} & & & & & & & & & & & & & & & & & & &$
viewing angi			$\emptyset = 0$ °		65		deg	FIG 3.	0
			Ø = 180°		65		deg	FIG 3.	
	Red	X			0.608				
	Reu	у			0.316				
	Green	X	$\theta=0^{\circ}$		0.305				
CIE (x, y)	Green	у	$\varnothing=0^{\circ}$		0.556			FIG 2.	5
chromaticity	X	Ta=25℃		0.135			110 2.		
	Diuc	у] 1a-23 C		0.137				
	White	X]		0.305				
	VV IIILE	у			0.334				

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)

Note 3. The uniformity in surface luminance $, \delta$ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

δ WHITE = Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.



FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

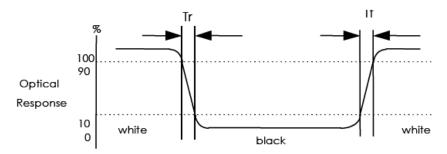
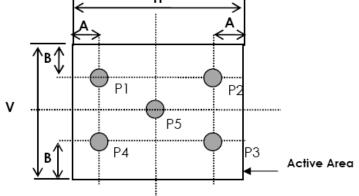


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

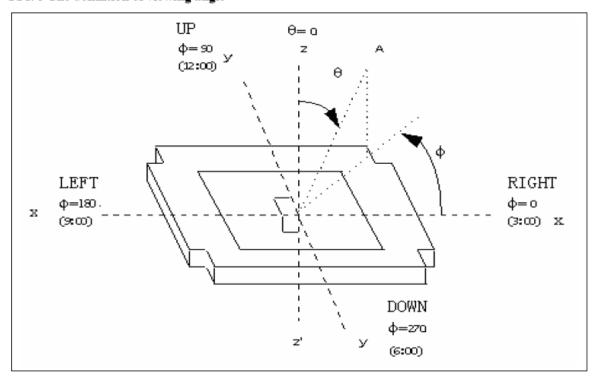


B:5 mm H,V:Active Area

A:5 mm

Light spot size ∅=7mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle





■INTERFACE DESCRIPTION

Pin No.	Symbol	I/O	Function	Remark
1	V_{LED}	Р	Power for LED backlight cathode	
2	V_{LED+}	Р	Power for LED backlight anode	
3	GND	Р	Power ground	
4	V_{DD}	Р	Power voltage	
5	R0	ı	Red data (LSB)	
6	R1	ı	Red data	
7	R2	ı	Red data	
8	R3	ı	Red data	
9	R4	ı	Red data	
10	R5	ı	Red data	
11	R6	I	Red data	
12	R7	ı	Red data (MSB)	
13	G0	I	Green data (LSB)	
14	G1	ı	Green data	
15	G2	I	Green data	
16	G3	I	Green data	
17	G4	I	Green data	
18	G5	ı	Green data	
19	G6	ı	Green data	
20	G7	I	Green data (MSB)	
21	В0	ı	Blue data (LSB)	

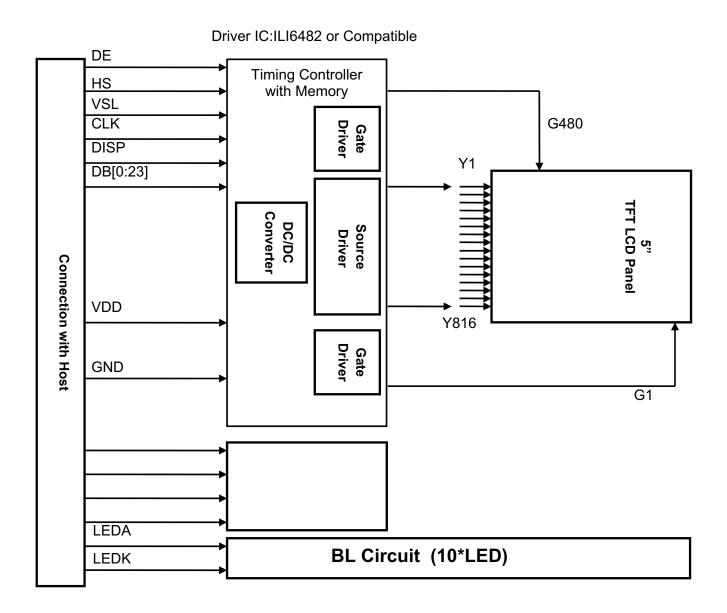


22	B1	I	Blue data
23	B2	I	Blue data
24	В3		Blue data
25	B4	l	Blue data
26	B5	I	Blue data
27	B6	I	Blue data
28	В7	I	Blue data (MSB)
29	GND	Р	Power ground
30	CLK	I	Pixel clock
31	DISP	I	Display on/off
32	HSYNı	-	Horizontal sync signal
33	VSYNC	-	Vertical sync signal
34	DE	I	Data Enable
35	NC	-	No Connector
36	GND	Р	Power ground
37	NC	1	No Connector
38	NC	-	No Connector
39	NC	-	No Connector
40	NC	-	No Connector

I: input, O: output, P: Power



■BLOCK DIAGRAM



■ APPLICATION NOTES

Please consult our technical department for detail information.

MODULE NO.: MI0500L1T-1

■ RELIABILITY TEST

No.	Test Item	Test Condition
1	High Temperature Storage	80 ± 2 °C/240hours
2	Low Temperature Storage	-30 ± 2 °C/240hours
3	High Temperature Operating	70 ± 2 °C/120hours
4	Low Temperature Operating	-20±2℃/120hours
5	Temperature Cycle	$-30\pm 2^{\circ}\text{C} \sim 25 \sim 80 \pm 2^{\circ}\text{C} \times 10 \text{ cycles}$ (30min.) (5min.) (30min.)
6	Damp Proof Test	$60 \text{C} \pm 5 \text{C} \times 90\% \text{RH/240} \text{hours}$
7	Vibration Test	Frequency: 10Hz~55Hz Amplitude of vibration: 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.
8	Packing drop test	According to ISTA 1A 2001.
9	Electrical static discharge	Air: ±4KV 150pF/330Ω 5 times
	and the same and the same go	Contact: ±2KV 150pF/330Ω5 time





■ INSPECTION CRITERION

Mir	OUTGOING QUALITY STANDARD	PAGE 1 OF 7
TITLE:FUNCTION	ONAL TEST & INSPECTION CRITERIA	MDS Product

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM.

1 Sample plan

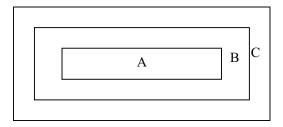
Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65 Minor defect: AQL 1.5

2. Inspection condition

Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line.

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig. 1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



4. Inspection standards

NO	Item	Criterion		
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker 		
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	 2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm. 		
	LCD and Touch Panel black	3.1 Round type: As following drawing $\Phi = (X+Y)/2$ $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5	
03	spots, white spots, contamination (non – display)	3.2 Line type: (As following drawing) Length(m Width(mm) Acceptable Q'ty m) $W \le 0.02$ Accept no dense $L \le 3.0$ $0.02 < W \le 0.05$ $L \le 2.5$ $0.03 < W \le 0.08$ $0.08 < W$ Rejection	2.5	
		* Densely spaced: No more than two lines within 3mm.		



NO	Item	Criterion A			AQL	
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ (n $\Phi \le 0.2$ $0.20 < \Phi \le 0.50 < \Phi \le 0.50 < \Phi \le 0.50 < \Phi \le 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.50 < 0.5$	20 ≦ 0.50 ≦ 1.00	Acceptable Q'ty Accept no dense 3 2 0 3	2.5
05	Scratches	Follow NO.3 -2 Line Type.				
06	Chipped glass	k: Seal width t: Glass thickness a L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack z: Chip thickness y: Chip wid Z≤1/2t Not over 1/2t< z≤2t Not ex Unit: mm If there are 2 or more chips, x is th 6.1.2 Corner crack: z: Chip thickness y: Chip wid Z≤1/2t Not over	th viewing area ceed 1/3k th viewing area ceed 1/3k th viewing area ceed 1/3k	x: Chip len $x \le 1$ $x \le 1$ ach chip $x \le 1$ $x \le 1$	gth /8a	2.5



Item			Criterion		A
	7.2 Protrusio	t: Glass thicknet pad length n over terminal:	z: Chip thickness ess a: LCD side leng	th	
		y: Chip width	x: Chip length	z: Chip thickness	
	7.2.2 Non-	y≦0.5mm	x≤1/8a	0< z≦t	
Glass crack	У	\(\frac{1}{x}\)	У ,	X	2
	7	X		X	
		y: Chip width	x: Chip length	z: Chip thickness	
		y≦L	x≤1/8a	0< z≦t	
	be inspect O If the production damaged.	ted according to elect duct will be heat seal	etrode terminal special ed by the customer,	fications. the alignment mark m	ust mot be
	W X	And Street, St	_		gth
	Glass crack	Clectrode 7.2 Protrusio 7.2.1 Chip or 7.2.2 Non- conductive properties Glass crack	L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad: y: Chip width y≤0.5mm 7.2.2 Non- conductive portion: Glass crack y: Chip width y≤L o If there chipped area touches to be inspected according to elected to the product will be heat seal damaged. 7.2.3 Substrate protuberance and	Class crack L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad: $y: Chip \ width \qquad x: Chip \ length$ $y \leq 0.5 mm \qquad x \leq 1/8a$ 7.2.2 Non-conductive portion: $y: Chip \ width \qquad x: Chip \ length$ $y \leq L \qquad x \leq 1/8a$ O If there chipped area touches the ITO terminal, over be inspected according to electrode terminal specific of the product will be heat sealed by the customer, in damaged. 7.2.3 Substrate protuberance and internal crack	L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad: $y : \text{Chip width} \qquad x: \text{Chip length} \qquad z: \text{Chip thickness} $ $y \le 0.5 \text{mm} \qquad x \le 1/8 \text{a} \qquad 0 < z \le t $ $y : \text{Chip width} \qquad x: \text{Chip length} \qquad z: \text{Chip thickness} $ $y \le 1/8 \text{a} \qquad 0 < z \le t $ $y : \text{Chip width} \qquad x: \text{Chip length} \qquad z: \text{Chip thickness} $ $y \le 1/8 \text{a} \qquad 0 < z \le t $ $y : \text{Chip width} \qquad x: \text{Chip length} \qquad z: \text{Chip thickness} $ $y \le 1/8 \text{a} \qquad 0 < z \le t $ $y : \text{Chip thickness} \qquad 0 < z \le t $ $y : \text{Chip thickness} \qquad 0 < z \le t $ $y : \text{Chip thickness} \qquad 0 < z \le t $ $y : \text{Chip thickness} \qquad 0 < z \le t $ $y : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $ $z : \text{Chip thickness} \qquad 0 < z \le t $



NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	 9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong. 	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	 11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart. 	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage \leq 1/2 FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage \leq 1/2 alignment area and can not affect the function , we judge accept.	2.5 2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle. 13.2 No short circuits in components on PCB or FPC.	2.5 0.65



NO	Item		Criterion			AQL
		L: Electrode pad length 14.1 General glass chip:	width z: Chip thickness a: L h Panel Total thickness a: L face and crack between panel			
		z: Chip thickness	y: Chip width	x: Chip length		
	Touch Panel	Z≦t	≤ 1/2 k and not over viewing area	x ≤ 1/8a	⊙ Unit:	
14	Chipped glass	mm ⊙ If there are 2 or more 14.1.2 Corner crack:	chips, x is the total length of	each chip	O Giida	2.5
		z: Chip thickness	y: Chip width	x: Chip length		
		z≦t	$\leq 1/2$ k and not over viewing area	x≤1/8a	⊙ Unit:	
		mm ⊙ If there are 2 or more	chips, x is the total length of	each chip		



N	O Item	Criterion	AQL	
1	Touch Panel(Fisl eye、dent a bubble or film)	nd	2.5	
1	Touch Pan Newton rir		2.5	
1	7 Touch Pan Linearity	Less than 2.5% is acceptable.		
1	8 LCD Ripp	Touch the touch panel , can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g		
1	9 General appearanc	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 		



■ PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
 - (9) Do not attempt to disassemble or process the LCD module.
 - (10) NC terminal should be open. Do not connect anything.
 - (11) If the logic circuit power is off, do not apply the input signals.
- (12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated



- (13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist LCM.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.



Handling precaution for LCM

LCM is easy to be damaged.

Please note below and be careful for handling!

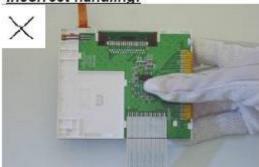
Correct handling:



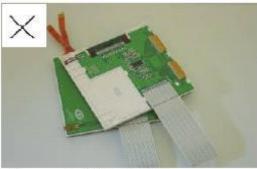


As above picture, please handle with anti-static gloves around LCM edges.

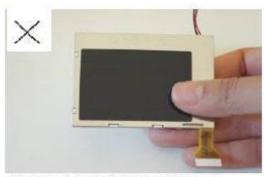
Incorrect handling:



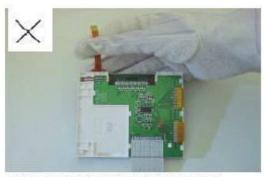
Please don't touch IC directly.



Please don't stack LCM.



Please don't hold the surface of panel.



Please don't stretch interface of output, such as FPC cable.



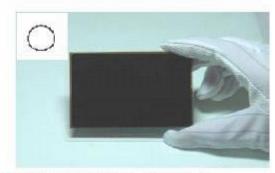
Handling precaution for LCD

LCD is easy to be damaged.

Please note below and be careful for handling!

Correct handling:





As above photo, please handle with anti-static gloves around LCD edges.

Incorrect handling:



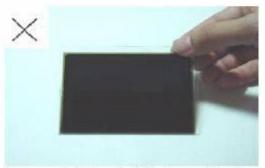
Please don't stack the LCDS.



Please don't hold the surface of LCD.



Please don't operate with sharp stick such as pens.



Please don't touch ITO glass without anti-static gloves.



Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped.

 Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

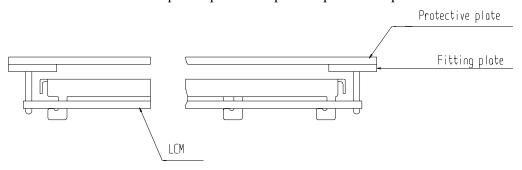
- Exposed area of the printed circuit board.
- -Terminal electrode sections.

USING LCD MODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

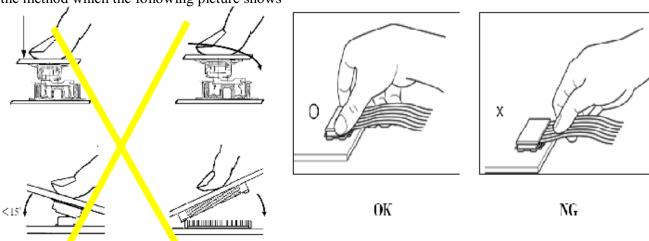
(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position,don't assemble or assemble like the method which the following picture shows





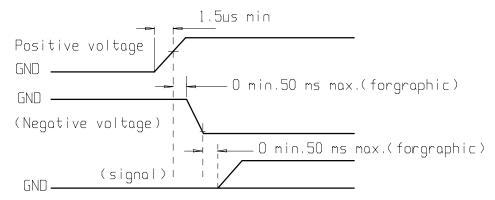
Precaution for soldering to the LCM

	Hand soldering	Machine drag soldering	Machine press soldering
No ROHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
product	Time : 3-5S.	Speed: 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa
ROHS	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
product	Time : 3-5S.	Time: 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa

- (1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- (2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- (3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

- (1) Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- (2) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- (3) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.
- (4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- (5) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature,50%RH or less is required.
 - (6) Input each signal after the positive/negative voltage becomes stable.
- (7) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.





MODULE NO.: MI0500L1T-1

Safety

- (1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- (2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Limited Warranty

Unless agreed betweenMulti-Inno and customer,Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replacement on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PRIOR CONSULT MATTER

- 1. ①For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without notice on our customer.
 - ②For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.